

N0D19S27

♦Outline(L*W*H): 1.6*1.5*0.55 mm

◆Good thermal dissipation & Optical uniformity

Table of Contents

Product Code Method	2
Maximum Rating	2
Typical Product Characteristics	3
Range of Bins	4
Electronic-optical Characteristics	 -5
Dimensions	6
Reflow Profile	7
Test Circuit and Handling Precautions	8
Packing	- 9
Precautions	- -11
Tast Itams and Dasults of Poliability	12

Features

- Forward current: green&blue: ≤25mA
- Typical viewing angle 50% Iv: 140°
- Lens color code: water transparent
- RoHS and REACH-compliant
- Qualified according to JEDEC moisturevity
 Level 3
- ESD level 1kV(HBM)

Applications

- Indoor signage display applications
- Indoor decorating and entertainment design
- Flat backlight for LCD. Switch and symbol
- Indicator and backlighting for all consumer electronics





■ Product Code Method

1	2	3	4	(5)
Process Type	Category	LED Type	Lead Frame Size	Dice Wavelength &Luminous Rank
1: normal process	S: SMD LED	A: PCB top view B: PCB side view	0606: 1.6*1.5 mm	B: blue G: green

6	7	8	9
Lap Polarity	Cap Color	PCB Module Code	Flow Code
1: common anode	C: water transparent	B: article mode	01: no expression above meaning for company

■ Maximum Rating(Ta=25°C)

Characteristics	Symbol		Typical	Unit
DOE 10		Blue(B)	25	A
DC Forward Current	I_{F}	Green(G)	25	mA
Pulse Forward Current*3		I_{PF}	100	mA
Reverse Current		V_R	5	V
5 5	D	Blue(B)	80	W
Power Dissipation	P _D	Green(G)	80	mW
Operating Temperature Range		T_{OP}	-40-80	°C
Storage Temperature Range		T_{STG}	-40-100	°C
Soldering Temperature*4		T_{SD}	260	°C

Notes 1: There is no maximum or typical voltage parameter

- 2: For other ambient, limited setting of current will be depended on de-rating curves.
- 3: Duty 1/10, pulse width 0.1ms
- 4: The maximum of soldering time is 5 seconds in $T_{\text{SD}}\,$

Version: IS-1.0 NO: BT-0606-15010901 Page 2 of 12



■ Typical Product Characteristics(Ta=25°C)

Symbol Unit **Test condition Characteristics** Min. Typ. Max. 10 $V_R=5V$ Leakage Current I_R μΑ Viewing Angle $2\theta_{1/2}$ 140 Deg $I_F=20mA$ Blue(B) 2.8 3.3 3.7 $I_F=10mA$ Forward Voltage V Green(G) 2.8 3.1 3.7 $I_F=10mA$ Blue(B) $I_F=10mA$ 60 **Luminous Intensity** Iv mcd Green(G) 330 $I_F=10mA$ Blue(B) 462.5 477.5 $I_F=10mA$ **Dominant Wavelength** λd nm Green(G) 520 535 $I_F=10mA$

Notes: 1. Measurement Errors:

Forward Voltage: ±0.1V, Luminous Intensity (Iv) ±10%, Dominant Wavelength (λd) ±1.0nm

2. Electrical-Optical Characteristics (Ta=25°C)





■ Range of Bins

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1) Forward Voltage Bins

Blue(I _F =10mA)				
Bin Code	Min.(mcd)	Max.(mcd)		
f	2.8	3.1		
g	3.1	3.4		
h	3.4	3.7		

Green(I _F =10mA)				
Bin Code Min.(mcd) Max.(mcd				
f	2.8	3.1		
g	3.1	3.4		
h	3.4	3.7		

2) Luminous Intensity Bins

Blue(I _F =10mA)					
Bin Code Min.(mcd) Max.(mcd)					
F	40	50			
G	50	63			
Н	63	80			
I	80	100			

Green(I _F =10mA)					
Bin Code	Max.(mcd)				
M	200	250			
N	250	320			
0	320	400			
P	400	500			

3) Dominant Wavelength Bins

Blue(I _F =10mA)				
Bin Code	Min.(nm)	Max.(nm)		
2	462.5	467.5		
3	467.5	472.5		
4	472.5	477.5		

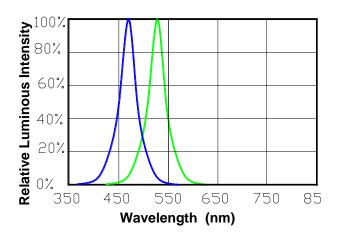
Green(I _F =10mA)				
Bin Code	Max.(nm)			
3	520	525		
4	525	530		
5	530	535		



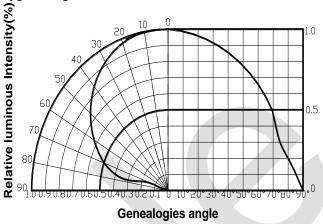
■ Electrical-Optical Characteristics

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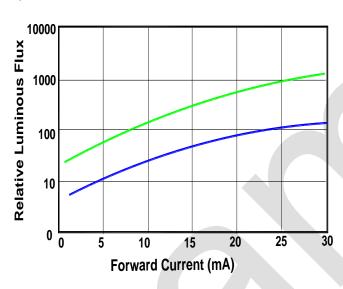
1). Relative Spectral Distribution



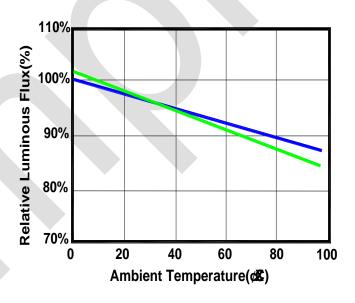
2). Typical Spatial Distribution



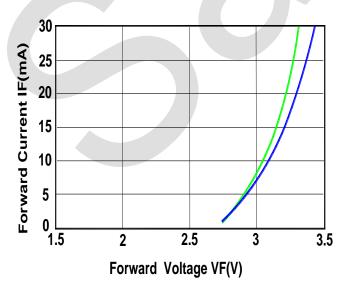
3). Relative Luminous Flux Vs Current



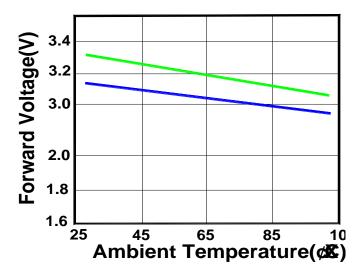
4). Relative Luminous Flux Vs Ambient Temperature



5). Electrical Characteristics

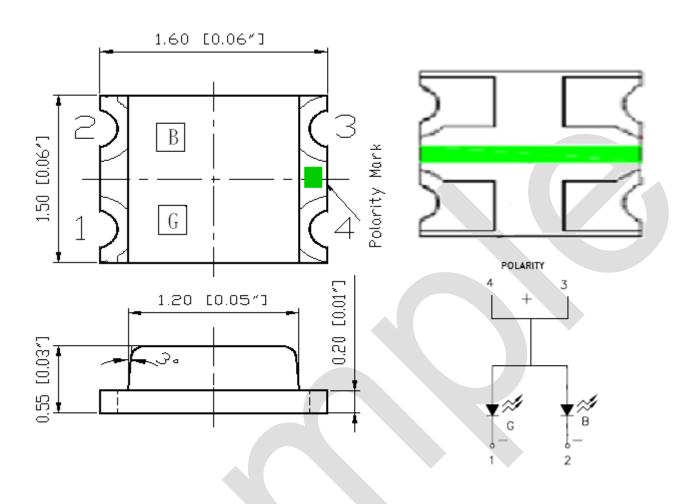


6). Forward Voltage Vs Temperature

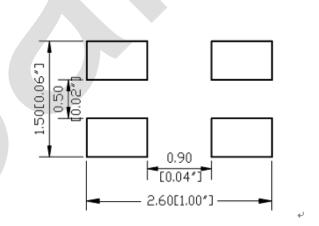




Dimensions







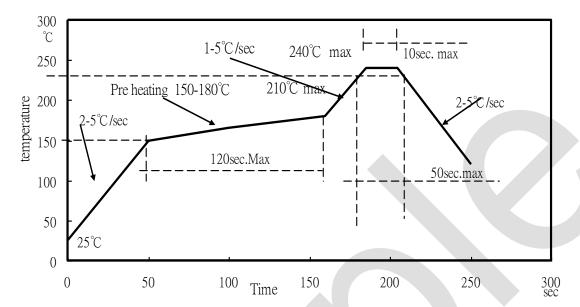
Notes: 1. All dimensions are in millimeters (inches)

- 2. Tolerance is ± 0.1 (± 0.004 ") mm unless otherwise noted
- 3. Specifications are subject to change without notice.

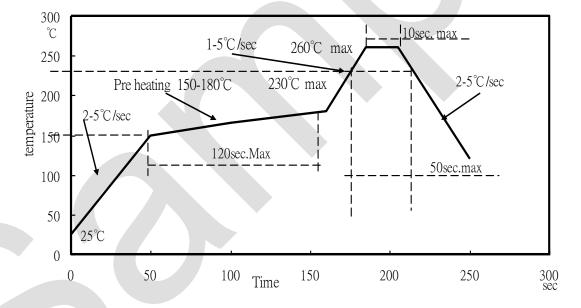


■ Reflow Profile

1. I_R reflow soldering profile for lead free solder



2. I_R reflow soldering profile for lead solder



Notes:

- 1. We recommend the reflow temperature 240°C ($\pm 5^{\circ}\text{C}$).the maximum soldering temperature should be limited to 260°C .
- 2. Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall be less than 3 times.

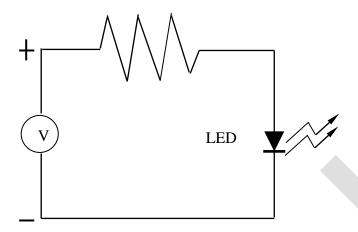
Version: IS-1.0 NO: BT-0606-15010901 Page 7 of 12



■ Test Circuit and Handling Precautions

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1. Test circuit



2. Handling precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C} (41^{\circ}\text{F} \sim 86^{\circ}\text{F})$

2). Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <60% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3. Baking

It is recommended to baking before soldering when the pack is unsealed after 24hrs.

The Conditions are as followings:

1). $60\pm3^{\circ}$ C X 6hrs and <5%RH, for reel

2). 125±3°C X 2hrs, for single LED

It shall be normal to see slight color fading of carrier (light yellow) after baking in process

Version: IS-1.0 NO: BT-0606-15010901 Page 8 of 12

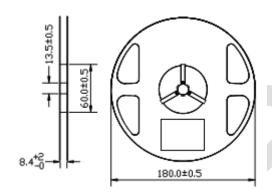


Packing

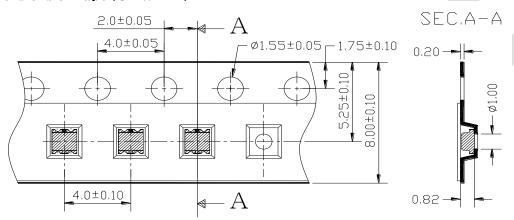
• Feeding Direction

Feeding Direction

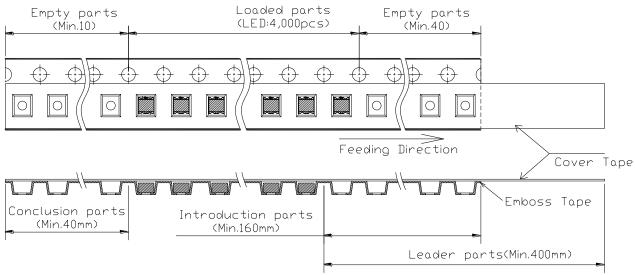
• Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



Arrangement of Tape



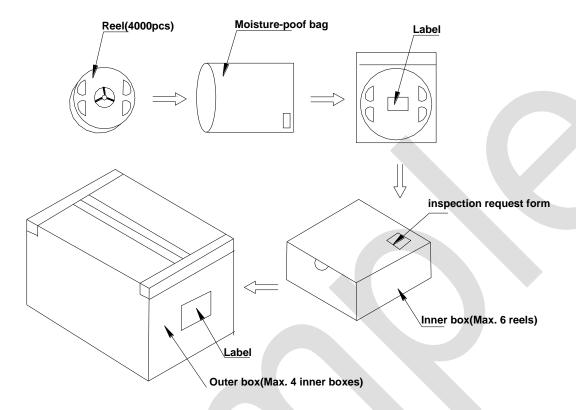
Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The max loss number of SMD is 2pcs;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
- 4. 4000pcs per reel



Packing

Packaging Specifications



Notes:

Reeled product (max.4,000) is packed in a sealed moisture-proof bag. Six bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.

Version: IS-1.0 NO: BT-0606-15010901 Page 10 of 12



Precautions

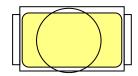
1. Abnormal situation caused by improper setting of collet

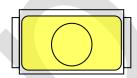
To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area





Picture $1(\sqrt{})$

Picture 2(X)

3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.
- 4. This usage and handling instruction is only for your reference.

Version: IS-1.0 NO: BT-0606-15010901 Page 11 of 12



■ Test Items and Results of Reliability

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Test Item	Test Conditions	Duration/ Cycle	Number of Damage	Reference
Temperature Cycle	-40°C 30min ↑↓ 1 min 85°C 30min	100 cycles	0/22	JEITA ED-4701 300 303
High Temperature Storage	T _a =100°C±5°C	1000 hrs	0/22	EIAJED-4701 200 201
High Humidity Heat Life Test	$T_a=85^{\circ}$ C RH=85% $I_F=20$ mA	500 hrs	0/22	Tested with Brightek standard
Humidity Heat Storage	T _a =85°C RH=85%	1000 hrs	0/22	EIAJED-4701 100 103
Life Test	$T_a=25^{\circ}C$ $I_F=20mA$	1000 hrs	0/22	Tested with Brightek standard
Low Temperature Life Test	$T_a=-40^{\circ}C$ $I_F=20mA$	1000 hrs	0/22	Tested with Brightek standard
High Temperature Life Test	$T_a=85^{\circ}C$ $I_F=20mA$	1000 hrs	0/22	Tested with Brightek standard

*Criteria for Judging						
Ttorn	Carroll of	Condition	Criteria for J	Judgment of pass Max USL*1×1.1		
Item	Symbol	Condition	Min	Max		
Forward Voltage	V_{F}	I _F =10mA	-	USL*1×1.1		
Reverse Current	I_R	$V_R = 5V$	-	10μΑ		
Luminous Intensity	Iv	I _F =10mA	LSL*2×0.7	-		

[Note] USL*1: Upper Specification Level

LSL*2: Lower Specification Level

Version: IS-1.0 NO: BT-0606-15010901 Page 12 of 12